

## **ST1S03**

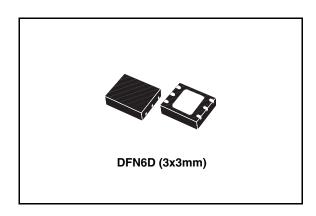
# 1.5 A, 1.5 MHz adjustable, step-down switching regulator

#### **Features**

- Step-down current mode PWM (1.5 MHz)
  DC-DC converter
- 2 % DC output voltage tolerance
- Internal soft start for START-UP current limitation and power on delay of 50-100 μs
- Typical efficiency: > 70 % over all operating conditions
- 1.5 A output current capability
- Not switching quiescent current: max 2.5 mA over temperature range
- Switch  $V_{DS}$ : max 350 mV @  $I_{SW}$  = 750 mA
- Uses tiny capacitors and inductors
- Available in DFN 3x3 mm exposed pad

#### **Description**

The ST1S03 is a step down DC-DC converter optimized for powering low-voltage digital core in HDD applications and, generally, to replace the high current linear solution when the power dissipation may cause an high heating of the application environment. It provides up to 1.5 A



over an input voltage range of 3 V to 16 V. An high switching frequency (1.5 MHz) allows the use of tiny surface-mount components: as well as the resistor divider to set the output voltage value, only an inductor, a schottky diode and two capacitors are required. Besides, a low output ripple is guaranteed by the current mode PWM topology and by the use of low ESR SMD ceramic capacitors. The device is thermal protected and current limited to prevent damages due to accidental short circuit. The ST1S03 is available in DFN6.

Table 1. Device summary

Order code	Packaging	Package
ST1S03PU	ST1S03PUR	DFN6D (3x3 mm)

March 2008 Rev 6 1/16

Contents ST1S03

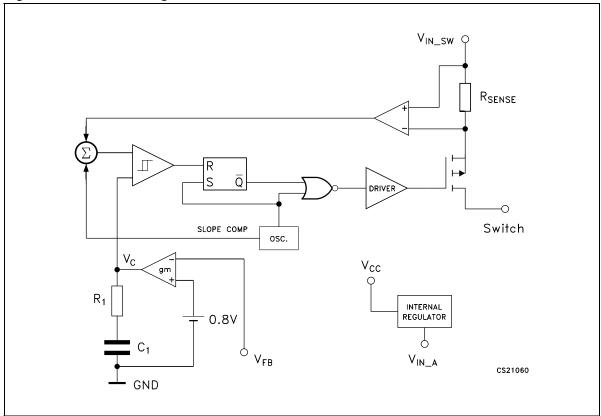
#### **Contents**

1	Diagram	3
2	Pin configuration	4
3	Maximum ratings	5
4	Electrical characteristics	6
5	Application notes	7
6	Typical application	8
7	Typical performance characteristics	9
8	Package mechanical data 1	2
9	Revision history 1	15

ST1S03 Diagram

## 1 Diagram

Figure 1. Schematic diagram



Pin configuration ST1S03

## 2 Pin configuration

Figure 2. Pin connections (top view)

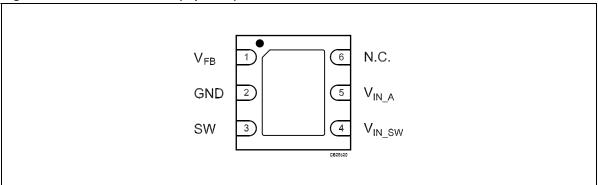


Table 2. Pin description

Pin n°	Symbol	Name and function
1	$V_{FB}$	Voltage of feedback
2	GND	System ground
3	SW	Output of the internal power switch
4	V <sub>IN_SW</sub>	Power supply for the MOSFET switch
5	V <sub>IN_A</sub>	Power supply for the analog circuit
6	N.C.	Not connected

ST1S03 Maximum ratings

## 3 Maximum ratings

Table 3. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>IN_SW</sub>	Positive power supply voltage	-0.3 to 16	V
V <sub>IN_A</sub>	Positive power supply voltage	-0.3 to 16	V
SWITCH voltage	Max voltage of output pin	-0.3 to 16	V
V <sub>FB</sub>	Feedback voltage	2.5	V
I <sub>VFB</sub>	Common mode input voltage	±1	mA
T <sub>J</sub>	Max junction temperature	150	°C
T <sub>STG</sub>	Storage temperature range	-25 to 150	°C
T <sub>LEAD</sub>	Lead temperature (Soldering) 10 Sec.	300	°C

Note: Absolute maximum ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied.

Table 4. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thJC</sub>	Thermal resistance junction-case	10	°C/W
R <sub>thJA</sub>	Thermal resistance junction-ambient	55	°C/W

Electrical characteristics ST1S03

#### 4 Electrical characteristics

Table 5. Electrical characteristics ( $V_{IN\_SW} = V_{IN\_A} = 5$  V,  $C_I = 4.7$   $\mu\text{F}$ ,  $C_O = 22$   $\mu\text{F}$ , L1 = 3.3  $\mu\text{H}$ ,  $T_J = 0$  to 125 °C, unless otherwise specified. Typical values are referred to 25 °C)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
FB	Feedback voltage	I <sub>O</sub> = 100mA	784	800	816	mV
I <sub>FB</sub>	V <sub>FB</sub> pin bias current				600	nA
ΙQ	Quiescent current	No Switching			2.5	mA
I <sub>O</sub>	Output current	V <sub>IN</sub> = 3V to 16V	1.5			Α
I <sub>MIN</sub>	Minimum output current		1			mA
%V <sub>O</sub> /ΔV <sub>IN</sub>	Reference line regulation	V <sub>IN</sub> = 3V to 16V		0.032	0.06	$^{8}V_{O}/_{\Delta V_{IN}}$
%V <sub>O</sub> /ΔI <sub>O</sub>	Reference load regulation	I <sub>O</sub> = 10mA to 1.2A		0.0014	0.003	%V <sub>O</sub> / mA
PWM f <sub>S</sub>	PWM switching frequency (1)	V <sub>FB</sub> = 0.8V, T <sub>A</sub> =25°C	1.2	1.5	1.8	MHz
D <sub>MAX</sub>	Maximum duty cycle			87		%
I <sub>SWL</sub>	Switching current limitation		1.65			Α
V <sub>DS</sub>	Switch V <sub>DS</sub>	I <sub>SW</sub> = 750 mA		200	350	mV
Е	Efficiency	I <sub>O</sub> =10mA to 1.2A	70			%
T <sub>SHDN</sub>	Thermal shut down <sup>(1)</sup>		130	150		°C
T <sub>HYS</sub>	Thermal shut down hysteresis (1)			15		°C
$\Delta V_{O}/\Delta I_{O}$	Load transient response (1)	$I_O$ = 100mA to 700mA $t_R$ = $t_F$ $\geq$ 100ns, $T_A$ = 25°C	-5		+5	%V <sub>O</sub>
$\Delta V_O/\Delta I_O$ @ $I_O$ =short	Short circuit removal response <sup>(1)</sup>	I <sub>O</sub> = 10mA to short, T <sub>A</sub> = 25°C			+5	%V <sub>O</sub>

<sup>1.</sup> Guaranteed by design, but not tested in production.

ST1S03 Application notes

### 5 Application notes

The ST1S03 is an adjustable current mode PWM step-down DC-DC converter with internal 1.5 A power switch, packaged in 6-lead DFN 3x3 mm.

It's a complete 1.5 A switching regulator with its internal compensation eliminating additional component.

The constant frequency, current mode, PWM architecture and stable operation with ceramic capacitors results in low, predictable output ripple. However, in order to keep the output regulated, the devices goes in pulse skipping mode when a very light load is required.

To clamp the error amplifier reference voltage a soft start control block generating a voltage ramp, has been implemented. Besides an on-chip power on reset of  $50 = 100 \, \mu s$  ensure the proper operation when switching on the power supply. Other circuits fitted to the device protection are the thermal shut down block which turn off the regulator when the junction temperature exceeds 150 °C typically and the cycle-by-cycle current limiting that provides protection against shorted outputs.

Being the ST1S03 an adjustable regulator, the output voltage is determined by an external resistor divider. The desired value is given by the following equation:

$$V_O = V_{FR} [1 + R1/R2]$$

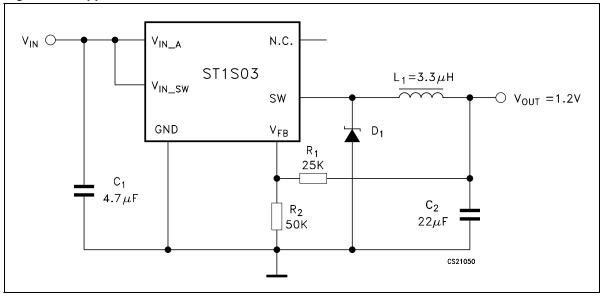
To make the device working, only other four external components are required: a Schottky diode, an inductor and two capacitors. The chosen inductor must be able to not saturate at the peak current level. Besides, its value can be selected keeping in account that a large inductor value increases the efficiency at low output current and reduces output voltage ripple, while a smaller inductor can be chosen when it is important to reduce the package size and the total cost of the application. Finally, the ST1S03 has been designed to work properly with X5R or X7R SMD ceramic capacitors both at the input and at the output. this kind of capacitors, thanks to their very low series resistance (ESR), minimize the output voltage ripple. Other low ESR capacitors can be used according to the need of the application without invalidating the right functioning of the device. Due to the high switching frequency and peak current, it is important to optimize the application environment reducing the length of the PCB traces and placing all the external component near the device.



Typical application ST1S03

# 6 Typical application

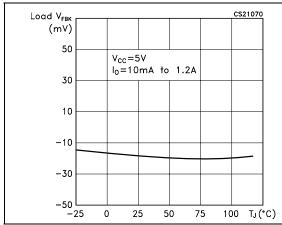
Figure 3. Application circuits



## 7 Typical performance characteristics

(L1 = 3.3  $\mu$ H, C<sub>I</sub> = 4.7  $\mu$ F, C<sub>O</sub> = 22  $\mu$ F, unless otherwise specified)

Figure 4. Load voltage feedback vs temp. Figure 5. Voltage feedback vs temperature



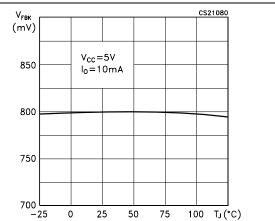
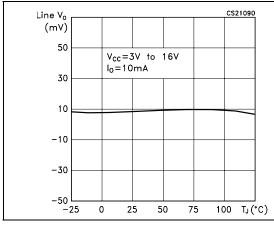


Figure 6. Line output voltage regulation vs temperature

Figure 7. Line voltage feedback vs temperature



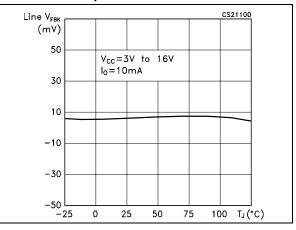
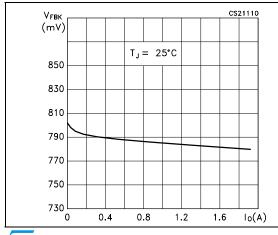


Figure 8. Voltage feedback vs output current Figure 9.

PWM Switching frequency vs temperature



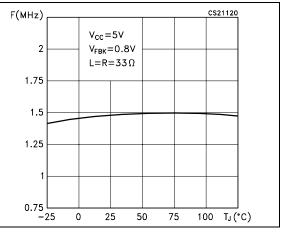
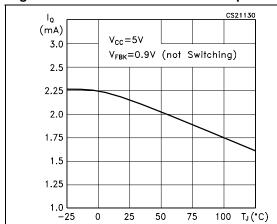


Figure 10. Quiescent current vs temperature Figure 11. Quiescent current vs input voltage



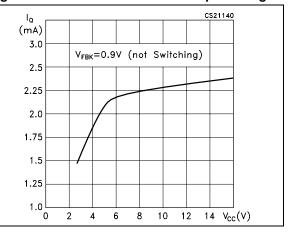
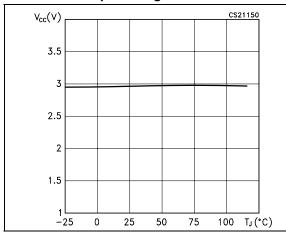


Figure 12. Minimum operating voltage vs output voltage

Figure 13. Efficiency vs temperature



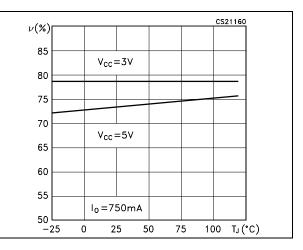
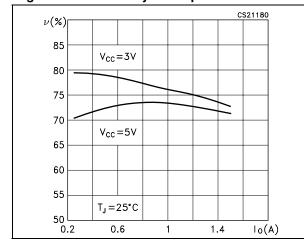


Figure 14. Efficiency vs output current

Figure 15. Switch V<sub>DS</sub> vs temperature



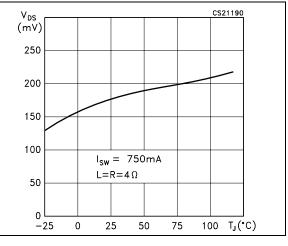
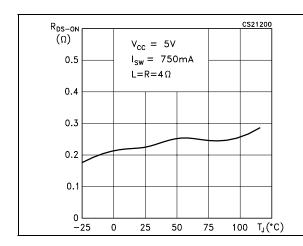


Figure 16. Switch RDS-ON vs temperature

Figure 17. Switch current limitation vs temperature



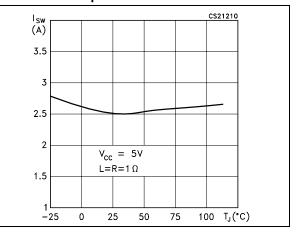
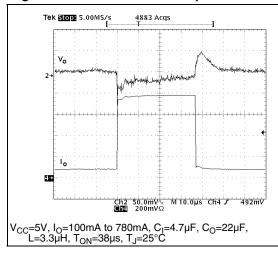


Figure 18. Load transient response

Figure 19. Load transient response



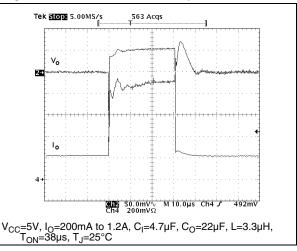
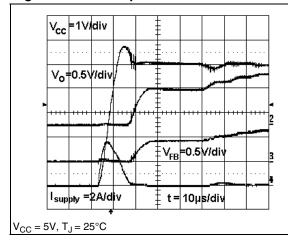
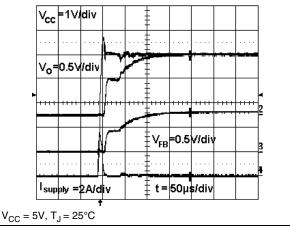


Figure 20. Start-Up transient

Figure 21. Start-Up transient





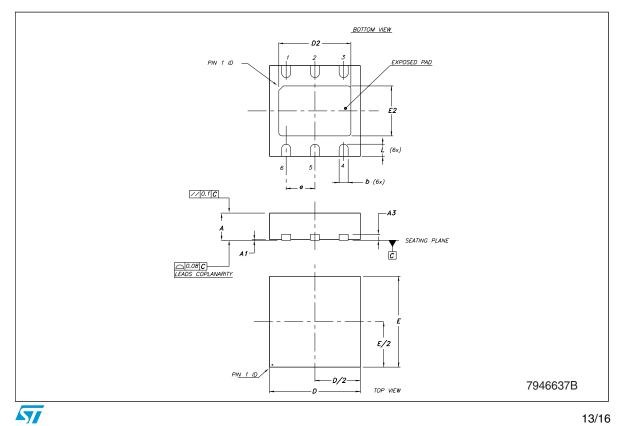
## 8 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

57

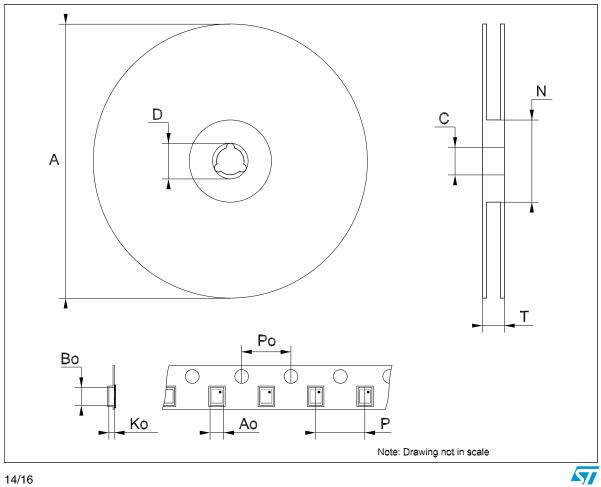
DFN6D	(3x3)	mm)	mechanical	data
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Dim		mm.		inch.		
Dim.	Min.	Тур.	Max.	Min.	Тур.	Max.
А	0.80		1.00	0.031		0.039
A1	0	0.02	0.05	0	0.001	0.002
А3		0.20			0.008	
b	0.23		0.45	0.009		0.018
D	2.90	3.00	3.10	0.114	0.118	0.122
D2	2.23		2.50	0.088		0.098
E	2.90	3.00	3.10	0.114	0.118	0.122
E2	1.50		1.75	0.059		0.069
е		0.95			0.037	
L	0.30	0.40	0.50	0.012	0.016	0.020



Tape & Reel QFNxx/DFNxx (3x3) Mechanical Data

Dim	mm.			inch.		
Dim.	Min.	Тур.	Max.	Min.	Тур.	Max.
А			330			12.992
С	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	60			2.362		
Т			18.4			0.724
Ao		3.3			0.130	
Во		3.3			0.130	
Ko		1.1			0.043	
Po		4			0.157	
Р		8			0.315	



ST1S03 Revision history

## 9 Revision history

Table 6. Document revision history

Date	Revision	Changes
11-Nov-2004	1	First Release.
08-Feb-2005	2	Maturity Change.
03-Mar-2005	3	Mistake on Figure 1, T <sub>J</sub> is changed 125 ==> 150°C on Table 3.
13-Jul-2005	4	Add new package SO-8 exposed pad.
29-Mar-2007	5	Package SO-8 removed.
07-Mar-2008	6	Removed: package mechanical data DFN6.

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577